



SPECIFICATION

(Approval sheet of GaAs Hall Sensor)

| Part Name | GaAs Hall Sensor | Image |
|---------------|--|-------|
| Product No. | HE41CY2B22 | |
| Customer Code | - | |
| Revision | Rev.09 | |
| Manufacturer | Futurecore Co., Ltd (Nanostech_Tianjin) | |

| DESIGNED BY | CHECKED BY | APPROVED BY |
|-------------|------------|-------------|
| | | |
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| 2025.11.25 | 2025.11.25 | 2025.11.25 |



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2. Electrical Characteristic

2.1 Absolute maximum ratings

[Ta=25°C]

| Parameter | Symbol | Rating | Unit |
|-----------------------------|--------|------------|------|
| Maximum Input Voltage | Vc | 8 | V |
| Maximum Power Dissipation | Pmax | 150 | mW |
| Operating Temperature Range | Top | -40 ~ +125 | °C |
| Storage Temperature Range | Tst | -40 ~ +150 | °C |

2.2 General electrical specifications

[Ta=25°C]

| Parameter | Symbol | Conditions | Min | Max | Unit |
|---------------------|--------|---------------------|------|------|------|
| Output Hall Voltage | Vh | Vin = 6V, B = 50mT | 78 | 102 | mV |
| Input Resistance | Rin | Ic = 0.1mA, B = 0mT | 1600 | 2400 | Ω |
| Output Resistance | Rout | Ic = 0.1mA, B = 0mT | 3200 | 4800 | Ω |
| Offset Voltage | Vo | Vin = 6V, B = 0mT | -8 | +8 | mV |

※ Vh = Vhm - Vo (Vhm : The output voltage measured at 50mT)

2.3 Other electrical specifications (For reference only)

[Ta=25°C]

| Parameter | Symbol | Conditions | Min | Max | Unit |
|---------------------|--------|--------------------------------|-----|-------|------|
| Temp. Coeff. of Vh | αVh | Ta = 25~125°C, B=50mT, Ic=5mA | - | -0.07 | %/°C |
| Temp. Coeff. of Rin | αRin | Ta = 25~125°C, B=0mT, Ic=0.1mA | - | 0.3 | %/°C |
| Linearity | ΔK | B=0.1T/0.5T Ic=5mA | -2 | +2 | % |

$$\text{※ } \alpha V_h : \frac{1}{V_h[T1]} \times \frac{V_h[T2] - V_h[T1]}{[T2 - T1]} \times 100$$

$$\text{※ } \Delta K : \frac{K[B1] - K[B2]}{[K(B1) + K(B2)] / 2} \times 100$$

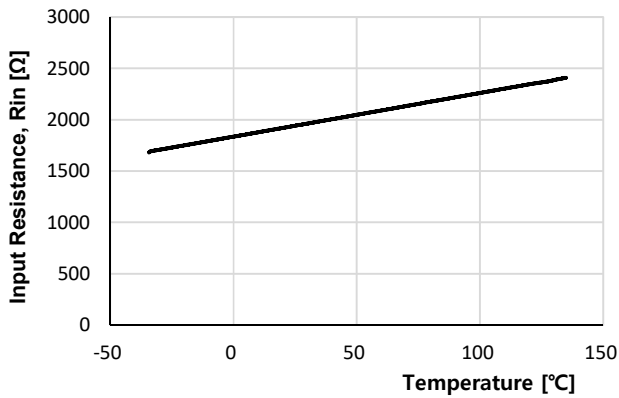
$$\text{※ } \alpha R_{in} : \frac{1}{R_{in}[T1]} \times \frac{R_{in}[T2] - R_{in}[T1]}{[T2 - T1]} \times 100$$

T1 = 25°C, T2 = 125°C
 K = Vh / (Ic*B)
 B1 = 0.5T, B2 = 0.1T

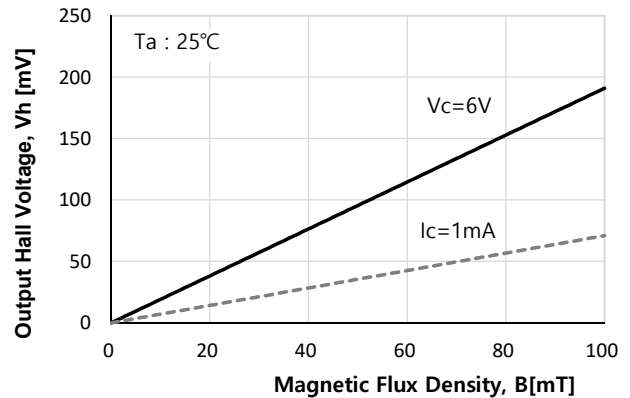


2.4 Characteristic graphs

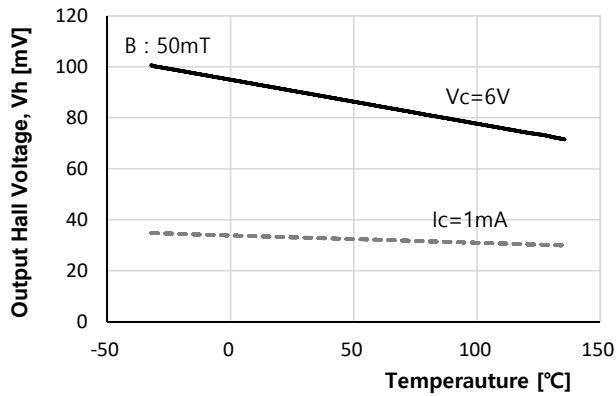
■ Rin-T



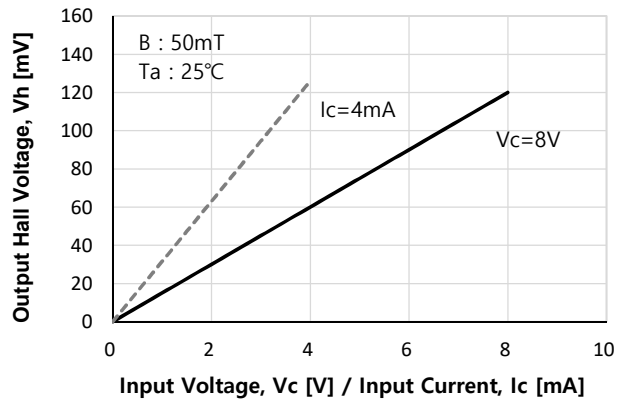
■ Vh-B



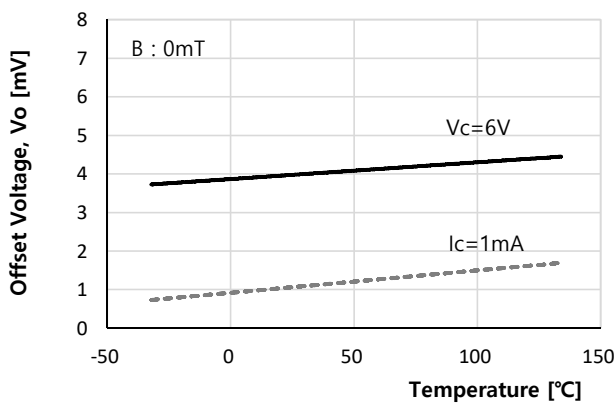
■ Vh-T



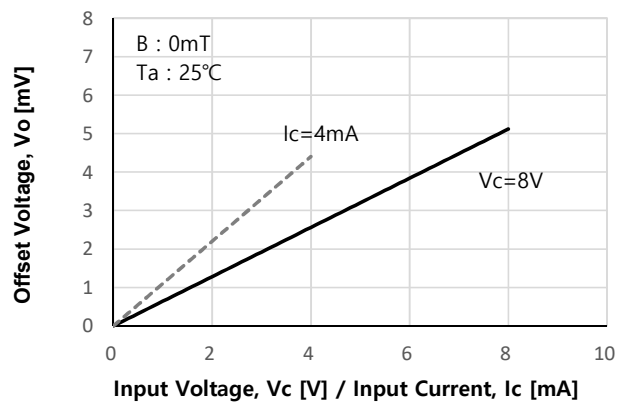
■ Vh-Vc, Vh-Ic



■ Vo-T [For reference only]



■ Vo-Vc, Vo-Ic [For reference only]



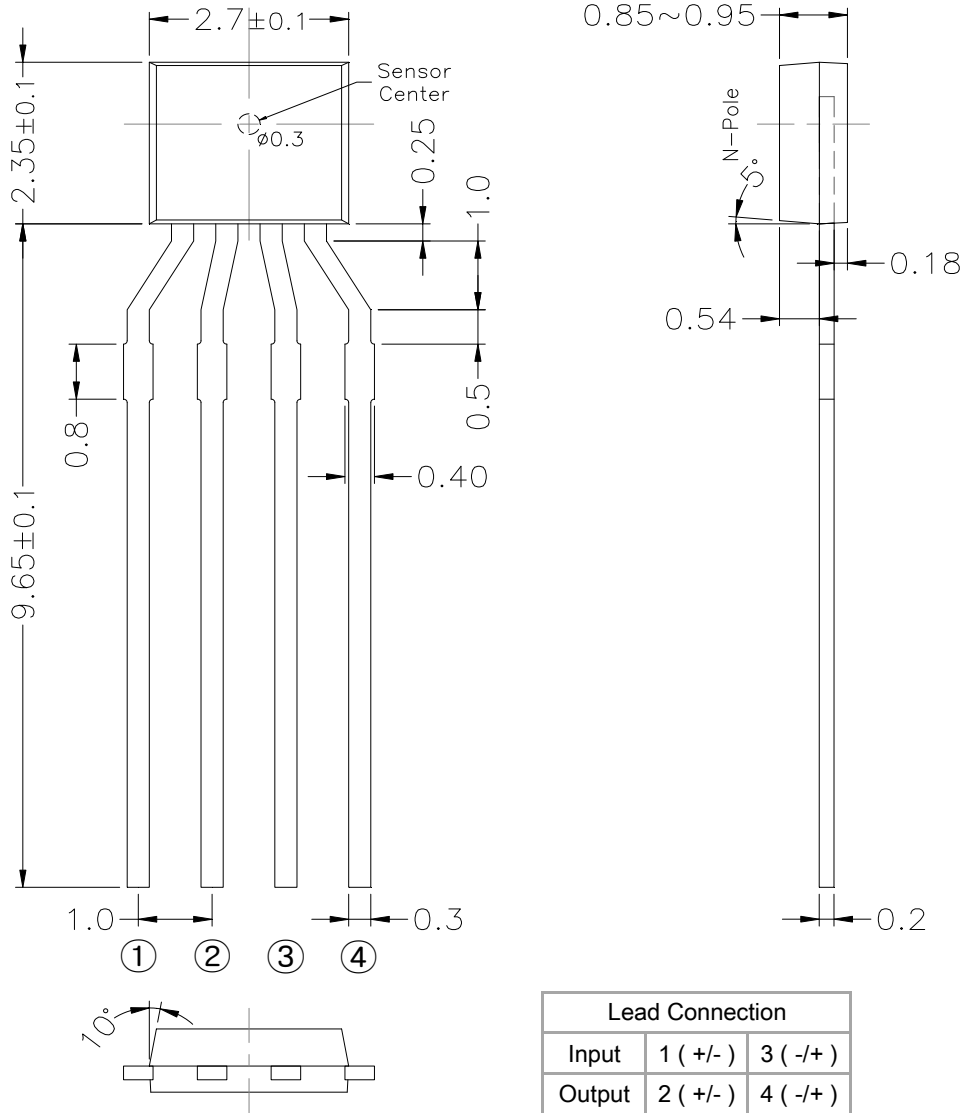
※ Magnetic Flux Density 1[mT] = 10 [G]



3. Package Specification

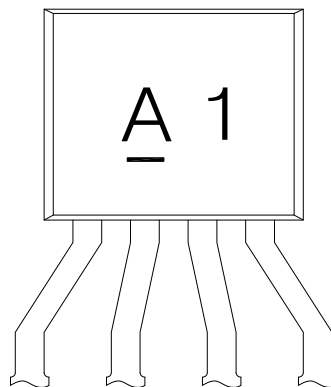
3.1 Package Dimensions [unit : mm]

1) Outline Dimension



2) Marking (Production Code)

- Ⓐ 1'st Character & Bar : Production Year/Month
- Ⓑ 2'nd Character : Production Date
- ※ Marking Method : Laser Marking





4. Marking Table

4.1 1'st Character & Bar : Production Year/Month

| 年 | 1月 | 2月 | 3月 | 4月 | 5月 | 6月 | 7月 | 8月 | 9月 | 10月 | 11月 | 12月 |
|------|----------|----------|----------|----------|----------|----------|----------|----------|----------|----------|----------|----------|
| 2023 | <u>5</u> | <u>6</u> | <u>7</u> | <u>8</u> | <u>9</u> | <u>A</u> | <u>B</u> | <u>C</u> | <u>D</u> | <u>E</u> | <u>F</u> | <u>G</u> |
| 2024 | <u>H</u> | <u>J</u> | <u>K</u> | <u>L</u> | <u>M</u> | <u>N</u> | <u>P</u> | <u>R</u> | <u>S</u> | <u>T</u> | <u>U</u> | <u>V</u> |
| 2025 | 5 | 6 | 7 | 8 | 9 | A | B | C | D | E | F | G |
| 2026 | H | J | K | L | M | N | P | R | S | T | U | V |
| 2027 | <u>5</u> | <u>6</u> | <u>7</u> | <u>8</u> | <u>9</u> | <u>A</u> | <u>B</u> | <u>C</u> | <u>D</u> | <u>E</u> | <u>F</u> | <u>G</u> |
| 2028 | <u>H</u> | <u>J</u> | <u>K</u> | <u>L</u> | <u>M</u> | <u>N</u> | <u>P</u> | <u>R</u> | <u>S</u> | <u>T</u> | <u>U</u> | <u>V</u> |

4.2 2'nd Character: Production Date

| | | | | | | | | | | | |
|------|----|----|----|----|----|----|----|----|----|----|----|
| Date | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | |
| Mark | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | A | |
| Date | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 | |
| Mark | B | C | D | E | F | G | H | J | K | L | |
| Date | 21 | 22 | 23 | 24 | 25 | 26 | 27 | 28 | 29 | 30 | 31 |
| Mark | M | P | R | S | T | U | V | W | X | Y | Z |



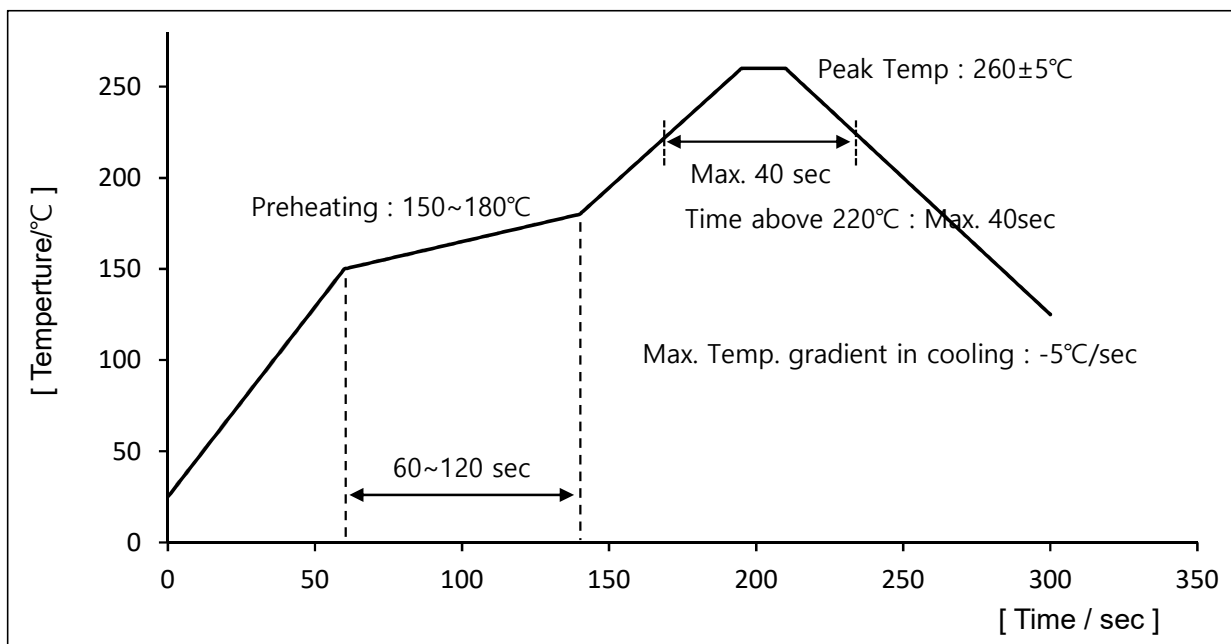
5. Reflow Profile

5.1 Lead Frame

- 1) The material of lead frame is phosphor bronze alloy and the die bonded surface is plated by silver.
The minimum thickness of plating is 3.0 μ m.
- 2) Lead is plated by pure Sn and the thickness is controlled by 4~12 μ m.

5.2 Reflow Condition (For Reference)

- 1) No rapid heating and cooling is desired.
- 2) Preheating is recommended for 1~2minutes at 150~180 $^{\circ}$ C.
- 3) Reflowing is recommended for 10~20seconds at 220~260 $^{\circ}$ C.
- 4) The number of times of reflow soldering should be two or less.
- 5) Solderability should be checked by yourself, because it is depend on solder material and other parameters.



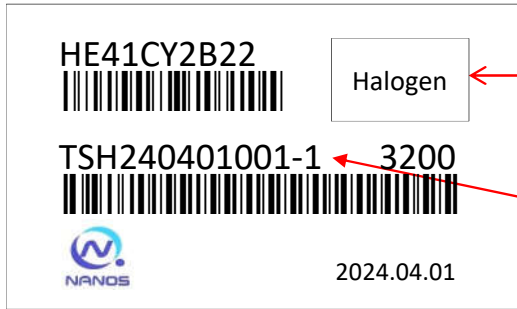
5.3 Soldering Method and Temperature (For Reference)

| Items | Methods | Temperature |
|-------------|--------------------------------------|-------------------------------|
| Reflow | Soldering by passing the heated zone | Max 260 $^{\circ}$ C in 10sec |
| Solder Iron | Soldering by solder-iron | Max 350 $^{\circ}$ C in 3sec |



6. Packing Structure

6.1 Label



Halogen

Halogen Free Label

Manufacturing Lot Number

6.2 Packing



1 Inner Box : 3,200ea Hall Sensor

Inspection Sheet



1 Outer Box : 12,800ea Hall Sensor



Packing Finished



7. Reliability Test Specification

7.1 Test item and condition

| No. | Test Item | Test condition | Quantity | Time |
|-----|-----------------------------|--|----------|---------|
| 1 | High Temp. High Humidity | Ta=85±5°C, Relative Humidity=85±5%RH | 22pcs | 1,000HR |
| 2 | High Temp. Operating | Ta=125±5°C, Vc=6.0V±10% | 22pcs | 1,000HR |
| 3 | Preconditioning | Preconditioning : Ta=150±5°C, 24HR Moisture Absorption : Ta=85±5°C, 85±5%RH, 168HR Reflow : Ta=260±5°C, 10sec | 22pcs | 2Cycle |
| 4 | High Temp. Storage | Ta=150±5°C | 22pcs | 1,000HR |
| 5 | Temp. Cycle | -55±5°C, 30min ↔ 25°C, 5min ↔ 150±5°C, 30min | 22pcs | 50Cycle |

7.2 Criterion for judging

After each reliability test, samples should be store at least 24hrs in room temp. & humidity, and then measure.

| Item | Spcification |
|------|-------------------------|
| Rin | Change rate [%] : ±20%↓ |
| Rout | |
| Vh | |
| Vo | Max. ±16mV |



8. Important Precautions

- 1) Reprinting or reproducing this document in whole or in part without our prior written consent is prohibited.

- 2) The storage period is one year in the vacuum packaging state, and one year in the vacuum packaging is opened.
(※ Product storage environment recommendation : N2 Gas & temperature below 30℃ & humidity 60% Rh)

- 3) The quality and performance of the product are guaranteed for one year based on the date of manufacture.
(This is based on the storage environment)

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